



Smart Fabrics Technologies and Applications

Guest Editor:

Prof. Dr. Giuseppe Andreoni

Technology and Design for
Healthcare Laboratory—
Politecnico di Milano, Dip. di
Design via Durando 38/A, 20158
Milano, Italy

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Message from the Guest Editor

Dear Colleagues,

Smart garments and their related technologies started about 20 years ago; nowadays, they are exploited into several applications. Today, clothes are able to measure signals, process data, communicate information, perform actions, provide protection against electrical, thermal, fire, or other agents, i.e., they are essential in several applications. These solutions belong to the more general category of wearable systems, which are smart integrated systems close to, or in contact with, the human body, and that are able to measure, process and transmit biomedical, physical and chemical data or parameters, and/or execute mechanical actions if necessary. They also integrate advanced technical fabrics and innovative processes for fabric functionalization, e.g., creation of flexible circuits, embroidery with conductive fibres, conductive ink printing, coupling different textile layers, etc.

This Special Issue aims to build and share a common vision, state-of-the-art knowledge and applications, new research frontiers, and challenges in Smart Fabrics Technologies and Applications.

Dr. Giuseppe Andreoni
Guest Editor





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Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo

Dipartimento di Fisica,
Politecnico di Milano, Piazza L.
da Vinci 32, 20133 Milano, Italy

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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Applied Sciences Editorial Office
MDPI, St. Alban-Anlage 66
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